RECTRON SEMICONDUCTOR
TECHNICAL SPECIFICATION

HFM108-W -S-R03

SURFACE MOUNT GLASS PASSIVATED HIGH EFFICIENCY SILICON RECTIFIER

VOLTAGE 1000 Volts CURRENT 1.0 Ampere

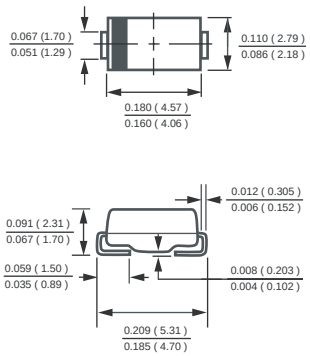
FEATURES

* Glass passivated device
* Ideal for surface mounted applications
* Low leakage current
* Metallurgically bonded construction
* Mounting position: Any
* Weight: 0.057 gram

MECHANICAL DATA

* Epoxy: Device has UL flammability classification 94V-O

DO-214AC



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.
resistive or inductive load.

MAXIMUM RATINGS (@ TA=25 °C unless otherwise noted)

RATINGS	SYMBOL	HFM108-W-S-R03	UNITS
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	1000	Volts
Maximum RMS Voltage	V_{RMS}	700	Volts
Maximum DC Blocking Voltage	V_{DC}	1000	Volts
Maximum Average Forward Rectified Current at T_A = 50°C	I_O	1.0	Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	30	Amps
Current Squarad Time	I^2t	3.7	A^2/Sec
Typical Thermal Resistance (Note 1)	$R_{\theta JL}$	27	°C/W
Typical Thermal Resistance (Note 1)	$R_{\theta JA}$	75	°C/W
Typical Junction Capacitance (Note 2)	C_J	12	pF
Reverse Energy	ER	25	mJ
Operating Temperature Range	T_J	150	°C
Storage Temperature Range	T_{STG}	-55 to + 150	°C

ELECTRICAL CHARACTERISTICS(@TA=25 °C unless otherwise noted)

CHARACTERISTICS		SYMBOL	HFM108-W-S-R03	UNITS
Maximum Instantaneous Forward Voltage at 1.0A DC		V_F	1.7	Volts
Maximum Full Load Reverse Current, Full cycle Average T_A =55°C		I_R	50	µA
Maximum Average Reverse Current	@T_A = 25°C		5	µA
at Rated DC Blocking Voltage	@T_A = 125°C		100	µA
Maximum Reverse Recovery Time (Note 4)		trr	75	nSec

NOTES : 1. Thermal Resistance : Mounted on PCB.
2. Measured at 1 MHz and applied reverse voltage of 4.0 volts.
3. "Fully ROHS compliant", "100% Sn plating (Pb-free)".
4. Test Conditions: I_F= 0.5A, I_R= -1.0A, I_{RR}= -0.25A.

2013-04
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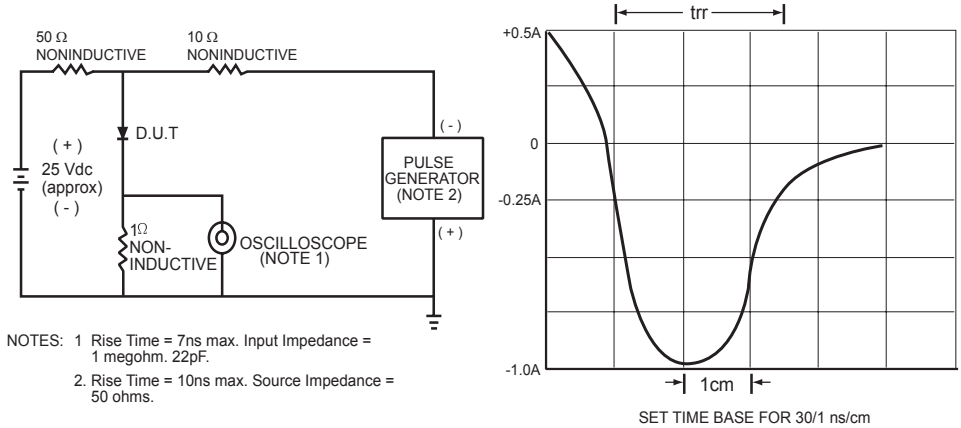
RATING AND CHARACTERISTICS CURVES (HFM108-W-S-R03)



NOTES: 1 Rise Time = 7ns max. Input Impedance = 1 megohm. 22pF.

2. Rise Time = 10ns max. Source Impedance = 50 ohms.

FIG.1 TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC

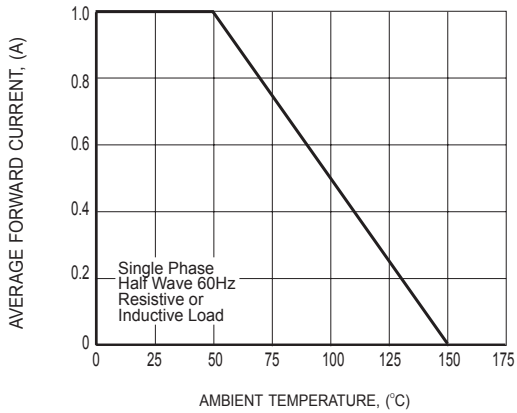


FIG.2 TYPICAL FORWARD CURRENT DERATING CURVE

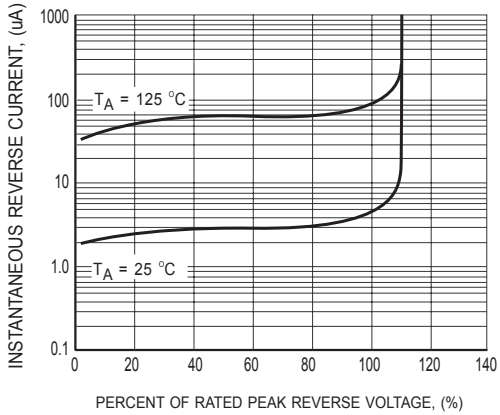


FIG.3 TYPICAL REVERSE CHARACTERISTICS

RATING AND CHARACTERISTICS CURVES (HFM108-W-S-R03)

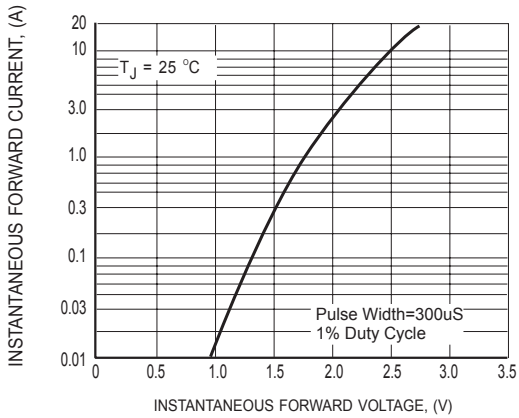


FIG.4 TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

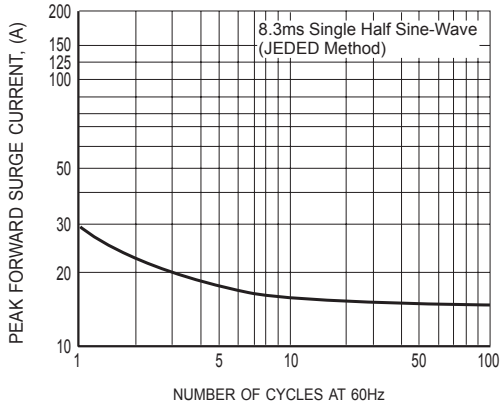


FIG.5 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

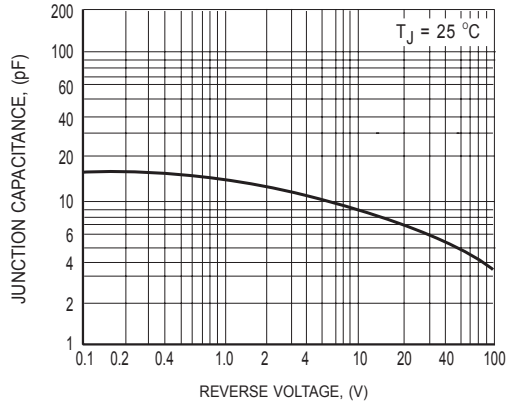
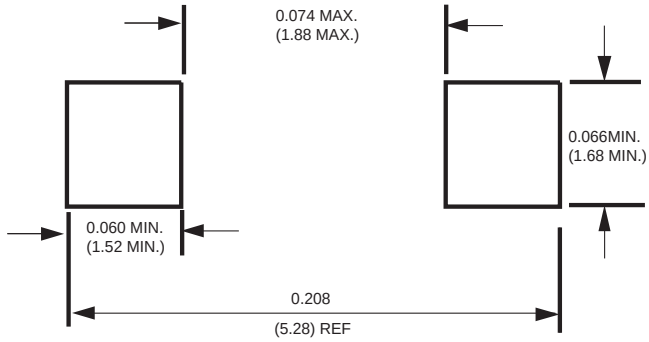


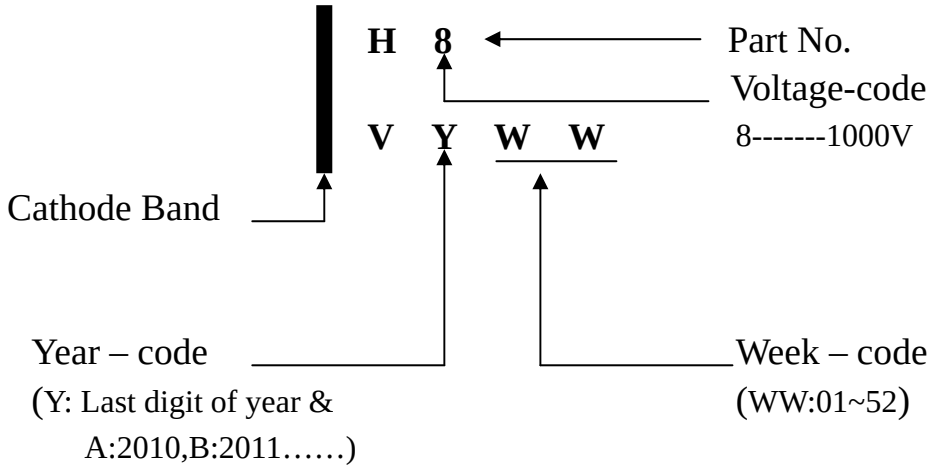
FIG.6 TYPICAL JUNCTION CAPACITANCE

Mounting Pad Layout



Dimensions in inches and (millimeters)

Marking Description



PACKAGING OF DIODE AND BRIDGE RECTIFIERS

REEL PACK

PACKAGE	PACKING CODE	EA PER REEL	COMPONENT SPACE(mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SMA	-T	1,500	---	---	178	390*205*310	48,000	8.40
SMA	-W	5,000	---	---	330	355*360*350	80,000	14.20

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